Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{i(max)} = 175 °C)

3. Applications

- Power factor correction
- UPS & energy storage systems
- PV MPPT circuit
- · 3-level rectifier and inverters

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage				1200		V
I _F	continuous forward current	T _{mb} ≤ 126 °C, DC; <u>Fig. 2</u>			50		А
T _j	junction temperature			-	55 to 17	'5	°C
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 50 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 50 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 50 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
Dynamic	characteristics				'	,	
Q _r	recovered charge	$I_F = 50 \text{ A}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $V_R = 400 \text{ V}$; $T_j = 25 ^{\circ}\text{C}$; Fig. 7		-	125	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		1/ 1/1 A
2	А	anode		K A 001aaa020
mb	mb	mounting base; connected to cathode	K A TO247-2L	

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	•	Package issue date
WNSC2D501200W	TO247-2L	WNSC2D501200W6Q	Tube	30	TO247L-2L(L)	10-Nov-2020
					TO247P-2L(P)	31-Mar-2023

7. Marking

Table 4. Marking codes

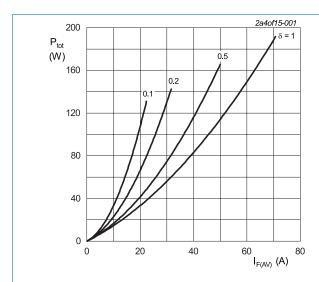
Type number	Marking codes
WNSC2D501200W	WNSC2D 501200W

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V_R	reverse voltage	DC		1200	V
I _F	continuous forward	T _{mb} ≤ 126 °C, DC; <u>Fig. 2</u>		50	Α
	current	T _{mb} ≤ 125 °C, DC; <u>Fig. 2</u>		51	Α
		$T_{mb} \le 25 ^{\circ}\text{C}, DC; \underline{\text{Fig. 2}}$		105	Α
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 125 °C; square-wave pulse		81	Α
I _{FSM}	non-repetitive peak	$t_p = 10 \text{ ms}; T_{j(init)} = 25 \text{ °C}; \text{ sine-wave pulse}$		420	Α
	forward current	t _p = 10 μs; T _{j(init)} = 25 °C; square-wave pulse		2400	Α
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$		882	A ² s
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C



$$\begin{split} I_{F(AV)} &= I_{F(RMS)} \times \sqrt{\delta} \\ V_o &= 1.252 \text{ V; } R_s = 0.0206 \text{ } \Omega \end{split}$$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

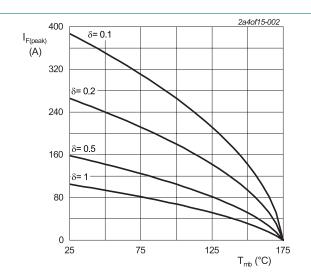
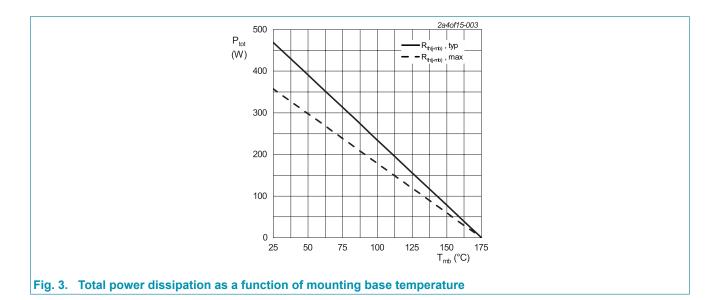


Fig. 2. Current derating as a function of mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	Fig. 4		-	0.32	0.42	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W

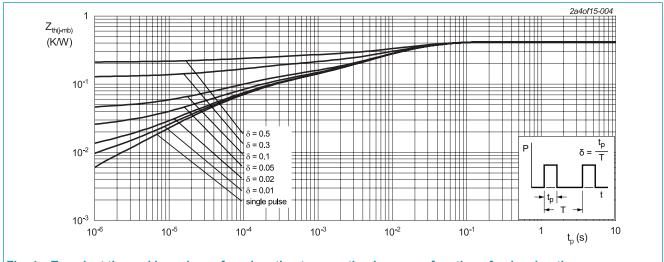
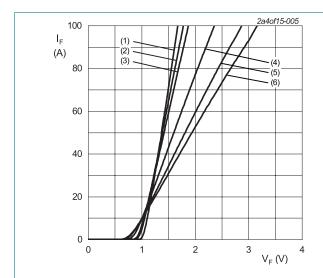


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

			Notes				
Symbol	Parameter	r Conditions		Min	Тур	Max	Unit
Static cha	aracteristics						
V_{F}	forward current	I _F = 50 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 50 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 50 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	1.5	250	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	50	-	μA
Dynamic	characteristics						
Q_r	recovered charge	$I_F = 50 \text{ A}$; $V_R = 400 \text{ V}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 7		-	125	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	2522	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	221	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	158	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 10.6 A; L = 10 mH; T _{j(init)} = 25 °C		540	-	-	mJ



 V_{o} = 1.252 V; R_{s} = 0.0206 Ω

(1) $T_i = -55$ °C; typical values

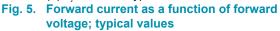
(2) $T_i = 0$ °C; typical values

(3) T_j = 25 °C; typical values

(4) T_j = 100 °C; typical values

(5) $T_j = 150$ °C; typical values

(6) $T_j = 175 \,^{\circ}\text{C}$; typical values



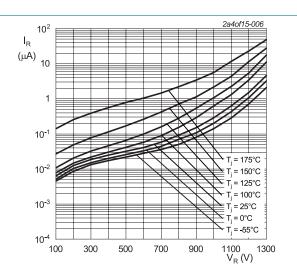
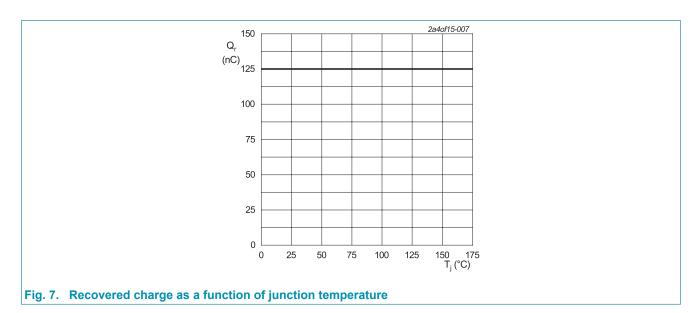
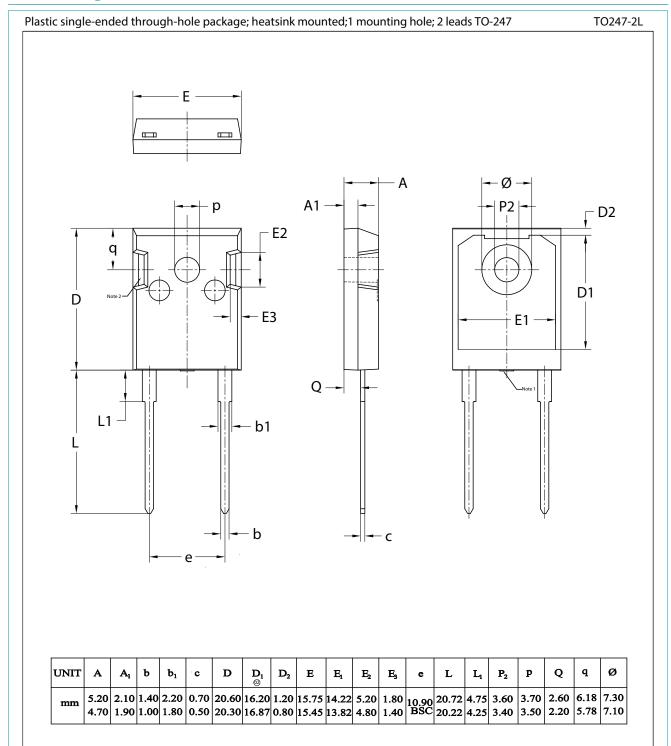


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value



11. Package outline



Note:

- 1. Mold resin protrusion max 0.127mm.
- 2. Metal exposed with Sn plating.

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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